

1. General description

The CBTL05023 is a multiplexer/demultiplexer switch chip for DisplayPort v1.2 signals and the control signals of a 10 Gbit/s channel. The 10 Gbit/s channel does not pass through this switch. This chip provides BIASOUT output control signal, and the DC-biasing pull-down resistors to facilitate an external 10 Gbit/s channel.

The AUX MUX is a 2 : 1 switch with CA_DETECT pin selecting between AUX and DDC (Direct Display Control) signals.

The DP MUX is a 2 : 1 switch that selects between DPML (DisplayPort Main Link) and LSTX/LSRX signals.

This chip also includes three control signal buffers: HPDOUT, CA_DETOUT and BIASOUT.

CBTL05023 is powered by a 3.3 V supply and it is available in 3 mm × 3 mm HVQFN24 package with 0.4 mm pitch.

2. Features and benefits

2.1 AUX MUX 2 : 1 switch

- This 2 : 1 switch is controlled by CA_DET signal multiplexing of the 1 Mbit/s differential AUX and DDC (Direct Display Control) signals
 - ◆ When CA_DET is HIGH, DDC path is selected
- Differential AUX channel:
 - ◆ Low insertion loss: -0.5 dB at 5 MHz
 - ◆ Low return loss: -19 dB at 5 MHz
 - ◆ Low ON-state resistance: 7.5 Ω
 - ◆ Bandwidth: 5 GHz
 - ◆ Low off-state isolation: -75 dB at 5 MHz
 - ◆ Low crosstalk: -40 dB at 5 MHz
 - ◆ Common-mode input voltage V_{IC} : 0 V to 3.3 V
 - ◆ Differential input voltage V_{ID} : 1.4 V (maximum)
- DDC channel has DDC_CLK and DDC_DAT I²C signals
 - ◆ 100 kHz 3.3 V voltage swing
- Both AUXIO+ and AUXIO- outputs have 900 Ω (± 20 %) pull-down resistor that is enabled by the status of the BIASOUT output pin
 - ◆ These pull-down resistors provide DC bias for the 10 Gbit/s channel



2.2 DP MUX 2 : 1 switch

The DP MUX is a 2:1 switch that is controlled by DP_PD pin multiplexing of a differential DPML signal and LSTX/LSRX signals

- The DPML (DisplayPort Main Link) runs up to HBR2 data rate of 5.4 Gbit/s
- The low speed DC coupled signals LSTX and LSRX are 3.3 V single-ended signals that operated at 1 Mbit/s
- 5.4 Gbit/s DPML channel:
 - ◆ Low insertion loss for DP-DPMLO path: -2.0 dB at 2.5 GHz
 - ◆ Low insertion loss for LS-DPMLO path: -2.0 dB at 2.5 GHz
 - ◆ Low return loss for DP-DPMLO path: -15 dB at 2.5 GHz
 - ◆ Low return loss for LS-DPMLO path: -14 dB at 2.5 GHz
 - ◆ Low ON-state resistance for DP-DPMLO path: 9 Ω
 - ◆ Low ON-state resistance for LS-DPMLO path: 13 Ω
 - ◆ High bandwidth: 7 GHz
 - ◆ Low off-state isolation: -20 dB at 2.5 GHz
 - ◆ Low crosstalk: -25 dB at 2.5 GHz
 - ◆ Common-mode input voltage V_{IC} : 0 V to 3.3 V
 - ◆ Differential input voltage V_{ID} : 1.4 V (maximum)

2.3 General

- The input of the HPDOUT (Hug Plug Detect output) buffer is 5 V tolerant
- HPDOUT, CA_DETOUT and BIASOUT buffers
 - ◆ CA_DET input leakage current < 0.1 μ A to prevent driving the 1 M Ω pull-down to a HIGH level
 - ◆ BIASOUT buffer is able to provide enough current to drive the bias circuit for the PIN diode path
 - ◆ BIASOUT buffer can drive up to six sets of bias circuits for the 10 Gbit/s paths
- When AUXIO_EN is LOW or (BIASIN = 0 and DP_PD = 1), this chip is in Sleep mode
 - ◆ AUXIO+ and AUXIO- of AUX MUX are disabled
 - ◆ CA_DETOUT and HPDOUT buffers are on
 - ◆ When the chip is in Sleep mode, CBTL05023 will consume < 3.5 mW
- Patent-pending high-bandwidth analog pass-gate technology
- Very low intra-pair differential skew (5 ps typical)
- All channels have back current protection
- All channels support rail-to-rail input voltage
- CMOS input buffer with hysteresis
- Single 3.3 V $\pm$ 10 % power supply
- HVQFN24 3 mm $\times$ 3 mm package, 0.4 mm pitch, with exposed center pad for thermal relief and electrical ground
- ESD: 2500 V HBM, 1250 V CDM
- Operating temperature range: 0 $^{\circ}$ C to 85 $^{\circ}$ C

3. Ordering information

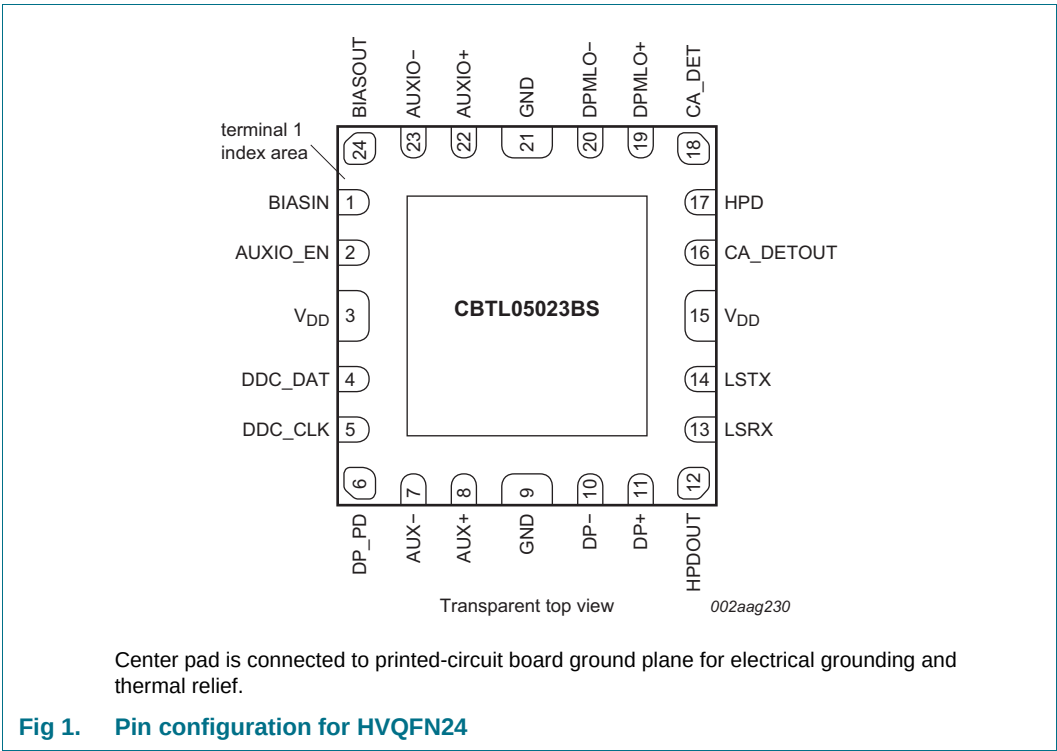
Table 1. Ordering information

Type number	Package		Version
	Name	Description	
CBTL05023BS	HVQFN24	plastic thermal enhanced very thin quad flat package; no leads; 24 terminals; body 3 × 3 × 0.85 mm ^[1]	SOT905-1

[1] Maximum package height is 1 mm.

4. Pinning information

4.1 Pinning



5. Package outline

HVQFN24: plastic thermal enhanced very thin quad flat package; no leads; 24 terminals; body 3 x 3 x 0.85 mm

SOT905-1

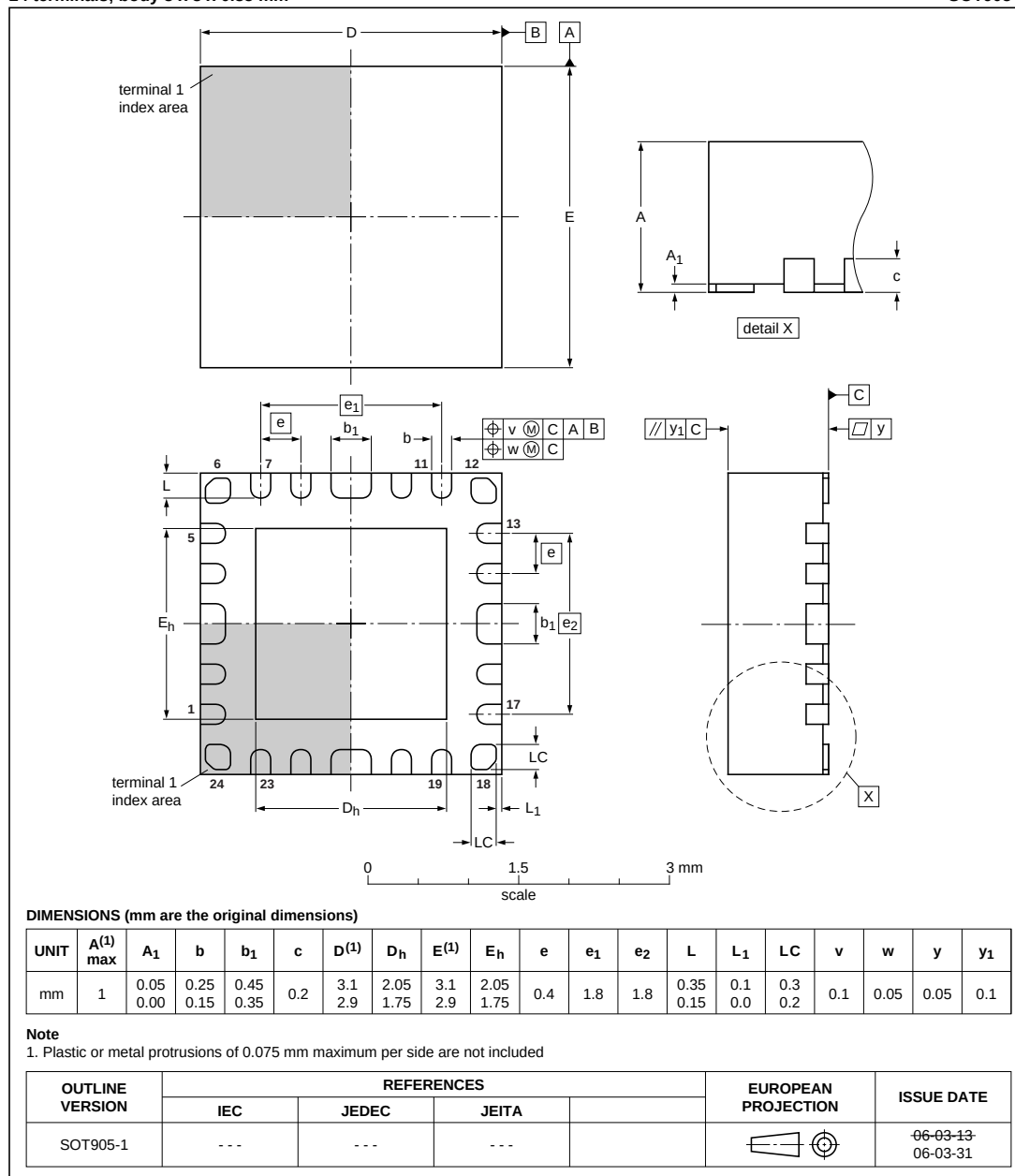


Fig 2. Package outline SOT905-1 (HVQFN24)

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For sales office addresses, please send an email to: salesaddresses@nxp.com

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